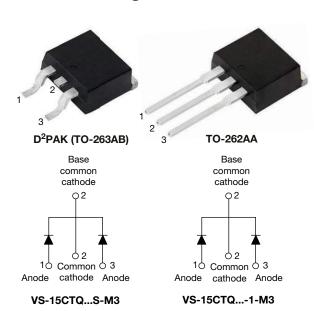


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High Performance Schottky Rectifier, 2 x 7.5 A



PRIMARY CHARACTERISTICS						
I _{F(AV)}	2 x 7.5 A					
V_{R}	35 V, 40 V, 45 V					
V _F at I _F	0.51 V					
I _{RM} max.	32 mA at 125 °C					
T _J max.	150 °C					
E _{AS}	10 mJ					
Package	D ² PAK (TO-263AB), TO-262AA					
Circuit configuration	Common cathode					

FEATURES

- 150 °C T_J operation
- Center tap configuration
- · Low forward voltage drop
- High frequency operation



- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The VS-15CTQ... center tap Schottky rectifier series has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL	VALUES	UNITS						
I _{F(AV)}	Rectangular waveform	15	А					
V _{RRM}	Range	35 to 45	V					
I _{FSM}	$t_p = 5 \mu s sine$	810	Α					
V _F	7.5 A _{pk} , T _J = 125 °C (per leg)	0.51	V					
TJ	Range	-55 to +150	°C					

VOLTAGE RATINGS							
PARAMETER	SYMBOL	VS-15CTQ035S-M3 VS-15CTQ035-1-M3	VS-15CTQ040S-M3 VS-15CTQ040-1-M3	VS-15CTQ045S-M3 VS-15CTQ045-1-M3	UNITS		
Maximum DC reverse voltage	V_R	35	40	45	V		
Maximum working peak reverse voltage	V_{RWM}	33	40	45	V		



VS-15CTQ...S-M3, VS-15CTQ...-1-M3 Series

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ABSOLUTE MAXIMUM RATINGS								
PARAMETER	SYMBOL	TEST COND	VALUES	UNITS				
Maximum average forward current See fig. 5	I _{F(AV)}	50 % duty cycle at T _C = 123 °C	15	Α				
Maximum peak one cycle		5 μs sine or 3 μs rect. pulse	Following any rated load	810				
non-repetitive surge current per leg See fig. 7	I _{FSM}	10 ms sine or 6 ms rect. pulse	condition and with rated V _{RRM} applied	145	А			
Non-repetitive avalanche energy per leg	E _{AS}	T _J = 25 °C, I _{AS} = 1.20 A, L = 11.10 mH		10	mJ			
Repetitive avalanche current per leg	I _{AR}		Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical					

ELECTRICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS			
		7.5 A	T _{.1} = 25 °C	0.55				
Maximum forward voltage drop per leg See fig. 1	V _{FM} ⁽¹⁾	15 A	1j=25 C	0.70	V			
	V FM (*)	7.5 A	T _{.1} = 125 °C	0.51				
		15 A	1J = 125 C	0.65				
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	V _R = Rated V _R	0.8	mA			
See fig. 2	IRM ***	T _J = 125 °C	VR = nateu VR	32	ША			
Maximum junction capacitance per leg	C _T	V_R = 5 V_{DC} (test signal range 100 kHz to 1 MHz), 25 °C		400	pF			
Typical series inductance per leg	L _S	Measured lead to lead 5 n	8.0	nΗ				
Maximum voltage rate of change	dV/dt	Rated V _R		10 000	V/µs			

Note

 $^{^{(1)}}$ Pulse width < 300 μ s, duty cycle < 2 %

THERMAL - MECHANI	THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum junction and storage temperature range		T _J , T _{Stg}		-55 to 150	°C			
Maximum thermal resistance, junction to case per leg		D	DC operation See fig. 4	3.50				
Maximum thermal resistance, junction to case per package		R _{thJC}	DC operation	1.75	°C/W			
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.50				
Approximate weight				2	g			
Approximate weight				0.07	oz.			
Mounting torque	minimum			6 (5)	kgf · cm			
Mounting torque	maximum			12 (10)	(lbf · in)			
Marking device			Case style D ² PAK (TO-263AB)	15CT(Q035S Q040S Q045S			
			Case style TO-262AA	15CTC	Q035-1 Q040-1 Q045-1			

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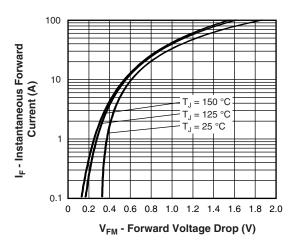


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

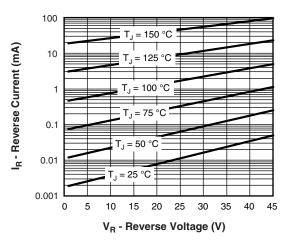


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

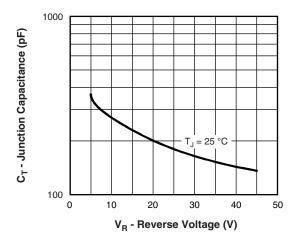


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

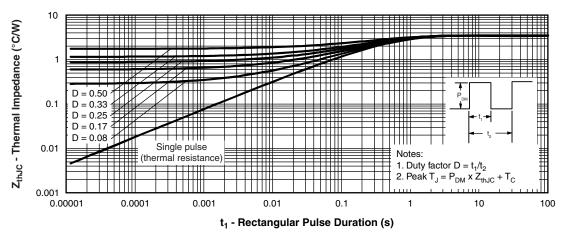


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

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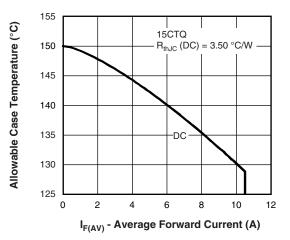


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

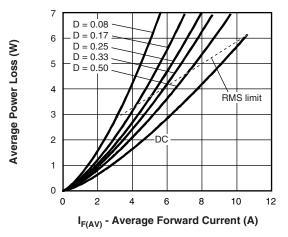


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

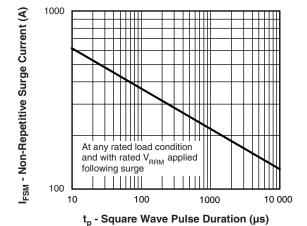


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

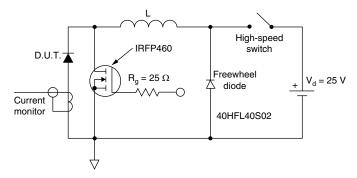


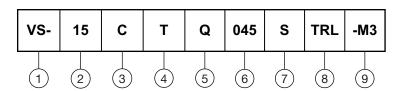
Fig. 8 - Unclamped Inductive Test Circuit

VS-15CTQ...S-M3, VS-15CTQ...-1-M3 Series

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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (15 A)

Circuit configuration: C = common cathode

4 - T = TO-220

5 - Schottky "Q" series 035 = 35 V

S = D²PAK (TO-263AB)

• -1 = TO-262AA

8 - • None = tube

• TRL = tape and reel (left oriented - for D²PAK (TO-263AB) only)

• TRR = tape and reel (right oriented - for D²PAK (TO-263AB) only)

9 - - M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

ORDERING INFORMATION		
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION
VS-15CTQ035S-M3	50	Antistatic plastic tubes
VS-15CTQ035STRL-M3	800	13" diameter plastic tape and reel
VS-15CTQ035STRR-M3	800	13" diameter plastic tape and reel
VS-15CTQ045S-M3	50	Antistatic plastic tubes
VS-15CTQ045STRL-M3	800	13" diameter plastic tape and reel
VS-15CTQ045STRR-M3	800	13" diameter plastic tape and reel
VS-15CTQ035-1-M3	50	Antistatic plastic tubes
VS-15CTQ040-1-M3	50	Antistatic plastic tubes
VS-15CTQ045-1-M3	50	Antistatic plastic tubes
VS-15CTQ035S-M3	50	Antistatic plastic tubes
VS-15CTQ035STRL-M3	800	13" diameter plastic tape and reel
VS-15CTQ035STRR-M3	800	13" diameter plastic tape and reel

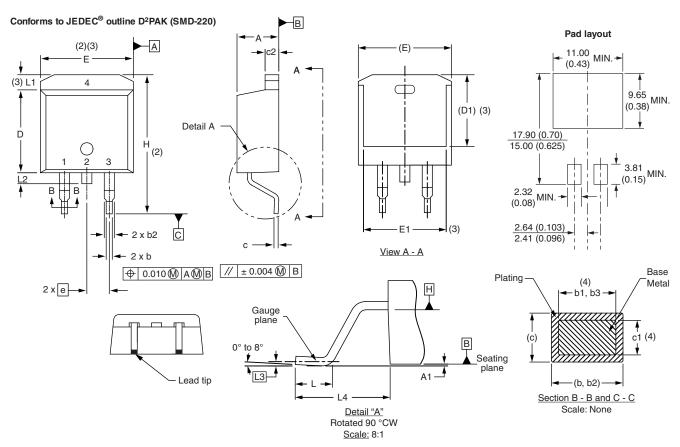
LINKS TO RELATED DOCUMENTS					
Dimensions	D ² PAK (TO-263AB)	www.vishay.com/doc?96164			
Differisions	TO-262AA	www.vishay.com/doc?96165			
Dort marking information	D ² PAK (TO-263AB)	www.vishay.com/doc?95444			
Part marking information	TO-262AA	www.vishay.com/doc?95443			
Packaging information		www.vishay.com/doc?96424			



Vishay Semiconductors

D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	OTES SYMBOL	MILLIM	ETERS	INC	HES	NOTES	
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOIES	NOTES	STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100) BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

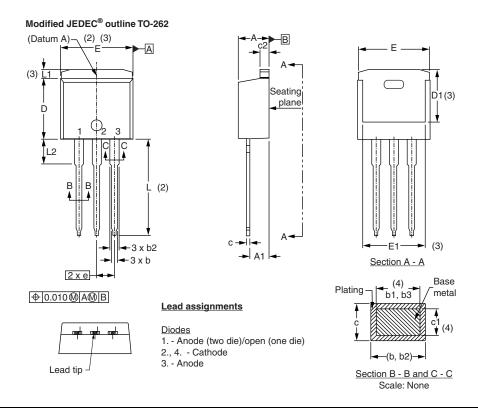
Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB

Vishay Semiconductors

TO-262

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	IETERS	INC	CHES	NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
С	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54	BSC	0.10	0 BSC	
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.36	3.71	0.132	0.146	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- 5) Controlling dimension: inches
- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum), D1 (minimum) and L2 where dimensions derived the actual package outline

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